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|--|------------------|---|---|--------------|-------------------------|---|---------------------------------------|--|----------------------------|
| APPLICANTS Fumitsugu Fukuyo, Hamamatsu-shi, JAPAN; Kenshi Fukumitsu, Hamamatsu-shi, JAPAN; Naoki Uchiyama, Hamamatsu-shi, JAPAN; Ryuji Sugiura, Hamamatsu-shi, JAPAN; ** CONTINUING DATA ******************************* This application is a 371 of PCT/JP03/11624 09/11/2003 ** FOREIGN APPLICATIONS ************************************ | | | | | | | | | |
| Foreign Priority claimed 35 USC 119 (a-d) conditions met Verified and Acknowledged yes no Met after Allowance Met after Linitials STATE OR COUNTRY JAPAN | | | | | SHEETS DRAWING 24 | | TOTAL CLAIMS 28 | | INDEPENDENT CLAIMS 8 |
| ADDRESS 023973 | | | | | | | | | |
| TITLE Method for cutting semiconductor substrate | | | | | | | | | |
| FILING FEE F RECEIVED N 2830 N | EES: lo lo | ES: Authority has been given in Paperto charge/credit DEPOSIT ACCOUNTfor following: | | | | All Fees 1.16 Fees (Filing) 1.17 Fees (Processing Ext. of time) 1.18 Fees (Issue) Other Credit | | | |